Preliminary Information

M2006-12



Integrated Systems, Inc.

VCSO BASED FEC CLOCK PLL WITH APS

GENERAL DESCRIPTION

The M2006-12 is a VCSO (Voltage Controlled SAW



Oscillator) based clock generator PLL designed for clock frequency translation and jitter attenuation. The device supports both forward and inverse FEC (Forward Error Correction) clock multiplication ratios. Multiplication ratios are

pin-selected from pre-programming look-up tables.

FEATURES

- Similar to the M2006-02 (and pin-compatible), but with an automatic protection switch (APS) function
- APS engages when a 4 ns or greater clock phase change is detected at the phase detector, such as might occur when reselecting reference clocks
- ♦ APS helps to ensure MTIE compliance by lowering loop bandwidth during the phase realignment
- ♦ APS is not recommended for complex FEC ratio translation when using an unstable reference; the M2006-02 is recommended for these applications
- ♦ In addition to the APS circuit, the APC (automatic phase compensation) pin enables absorption of the input phase change.
- Supports input reference and VCSO frequencies up to 700MHz, supports loop timing modes
- Single 3.3V power supply
- Small 9 x 9 mm SMT (surface mount) package

SIMPLIFIED BLOCK DIAGRAM

PIN ASSIGNMENT (9 x 9 mm SMT)



Figure 1: Pin Assignment

Example I/O Clock Frequency Combinations Using M2006-12-622.0800 and Inverse FEC Ratios

FEC PLL Ratio Mfec / Rfec	Base Input Rate ¹ (MHz)	Output Clock (either output) MHz
1/1	622.0800	
239/255	663.7255	622.08
238/255	666.5143	or
237/255	669.3266	155.52
236/255	672.1627	

Table 1: Example I/O Clock Frequency Combinations

Note 1: Input reference clock can be the base frequency shown divided by "Mfin" (as shown in Table 3 on pg. 3).



Figure 2: Simplified Block Diagram



DETAILED BLOCK DIAGRAM



Figure 3: Detailed Block Diagram

PIN DESCRIPTIONS

Number	Name	I/O	Configuration	Description
1, 2, 3, 10, 14, 26	GND	Ground		Power supply ground connections.
4 9	OP_IN nOP_IN	Input	_	
5 8	nOP_OUT OP_OUT	Output	_	External loop filter connections. See Figure 4.
6 7	nVC VC	Input		
11, 19, 33	VCC	Power		Power supply connection, connect to +3.3V.
12, 13 15, 16	FOUT1, nFOUT1 FOUT0, nFOUT0	Output	No internal terminator	Clock output pairs. Differential LVPECL.
17 18	P1_SEL P0_SEL	Input	Internal pull-down resistor ¹	P Divider controls. LVCMOS/LVTTL. (For P0_SEL, P1_SEL, see Table 5 on pg. 3.
20 21	nDIF_REF1 DIF_REF1	Input	Internal pull-down resistor ¹	Reference clock input pair 1. Differential LVPECL or LVDS.
22	REF_SEL	Input	Internal pull-down resistor ¹	Reference clock input selection. LVCMOS/LVTTL: Logic 1 selects DIF_REF1, nDIF_REF1. Logic 0 selects DIF_REF0, nDIF_REF0.
23 24	nDIF_REF0 DIF_REF0	Input	Internal pull-down resistor ¹	Reference clock input pair 0. Differential LVPECL or LVDS.
25	APC	Input	Internal pull-down resistor ¹	Automatic Phase Compensation. LVCMOS/LVTTL: Logic 1 - Device absorbs input phase transients. Logic 0 - Device doesn't absorb transients.
27 28	FIN_SEL1 FIN_SEL0	Input	Internal pull-down resistor ¹	Input clock frequency selection. LVCMOS/LVTTL. (For FIN_SEL1:0, see Table 3 on pg. 3.
29 30 31 32	FEC_SEL0 FEC_SEL1 FEC_SEL2 FEC_SEL3	Input	Internal pull-up resistor ¹	FEC PLL divider ratio selection. LVCMOS/LVTTL. (For FEC_SEL3:0, see Table 4 on pg. 3.)
34, 35, 36	DNC			Do Not Connect.

Note 1: For typical values of internal pull-down and pull-up resistors, see DC Characteristics (Pull-down and Pull-up) on pg. 7.

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PLL DIVIDER LOOK-UP TABLES

Mfin (Frequency Input) Divider Look-Up Table (LUT)

The FIN_SEL1:0 pins select the feedback divider value ("Mfin").

FIN_SEL1:0		Mfin Value	^{M2006-12-622.0800} Sample Ref. Freq. (MHz) ¹
1	1	1	622.08 ²
1	0	4	155.52
0	1	8	77.76
0	0	32	19.44

 Table 3: Mfin (Frequency Input) Divider Look-Up Table (LUT)

 Note 1: Example with M2006-12-622.0800 and "Non-FEC ratio" selection made from Table 4 (FEC_SEL2=1).

Note 2: Do not use with FEC_SEL3:0=1100 or 1101.

FEC PLL Ratio Dividers Look-up Table (LUT)

The FEC_SEL3:0 pins select the FEC feedback and reference divider values Mfec and Rfec.

FE(C_S	EL	3:0	Mfec	Rfec	Description	
0	0	0	0	236	255	Inverse FEC ratio	
0	0	0	1	79	85	Inverse FEC ratio, equivalent to 237/255	
0	0	1	0	14	15	Inverse FEC ratio, equivalent to 238/255	
0	0	1	1	239	255	Inverse FEC ratio	
0	1	0	0	236	236	Non-FEC ratio, complement to 000 ¹	
0	1	0	1	79	79	Non-FEC ratio, complement to 001 ¹	
0	1	1	0	14	14	Non-FEC ratio, complement to 010 ¹	
0	1	1	1	239	239	Non-FEC ratio, complement to 011 ¹	
1	0	0	0	255	236	FEC ratio	
1	0	0	1	85	79	FEC ratio, equivalent to 255/237	
1	0	1	0	15	14	FEC ratio, equivalent to 255/238	
1	0	1	1	255	239	FEC ratio	
1	1	0	0	1	1	Non-FEC ratio. Do not use when	
1	1	0	1	2	2	FIN_SEL1:0=11. The maximum phase detector frequency is 175MHz ²	
1	1	1	0	4	4		
1	1	1	1	8	8	NON-FEC ratio -	

Table 4: FEC PLL Ratio Dividers Look-up Table (LUT)

Note 1: The complementary "Inverse FEC ratio" and "Non-FEC ratio" selections use the same Mfec Divider ratio. This results in the same PLL loop bandwidth and damping factor for both selections, enabling them to be actively switched in a given application. See "Maintaining PLL Lock:" on pg. 4.

Note 2: The various "Non-FEC ratio" settings can be used to actively change PLL loop bandwidth in a given application.

Post-PLL Dividers

The M2006-12 also features two post-PLL dividers, one for each output pair. The "P1" divider is for FOUT1 and nFOUT1; the "P0" divider is for FOUT0 and nFOUT0.

Each divides the VCSO frequency to produce one of two output frequencies (1/4 or 1/1 of the VCSO frequency). The P1_SEL and P0_SEL pins each select the value for their corresponding divider.

P1_SEL, P0_SEL	P Value	M2006-12-622.0800 Output Frequency (MHz)				
1	4	155.52				
0	1	622.08				
Table 5: P Divider Selector Values and Frequencies						

Table 5: P Divider Selector, Values, and Frequencies

FUNCTIONAL DESCRIPTION

The M2006-12 is a PLL (Phase Locked Loop) based clock generator that generates output clocks synchronized to one of two selectable input reference clocks.

An internal high "Q" SAW filter provides low jitter signal performance and controls the output frequency of the VCSO (Voltage Controlled SAW Oscillator).

Configurable FEC feedback and reference dividers (the "Mfec Divider" and "Rfec Divider") provide the multiplication ratios necessary to accomodate clock translation for both forward and inverse Forward Error Correction.

In addition, a configurable feedback divider (labeled "Mfin Divider") provides the broader division options needed to accomodate various reference clock frequencies.

For example, the M2006-12-622.0800 (see "Ordering Information" on pg. 8) has a 622.08MHz VCSO frequency:

- The inverse FEC PLL ratios (at top of Table 4) enable the M2006-12-622.0800 to accept "base" input reference frequencies of: 663.7255, 666.5143, 669.3266, 672.1627, and 622.08MHz.
- The Mfin feedback divider enables the actual input reference clock to be the "base" input frequency divided by 1, 4, 8, or 32. Therefore, for the base input frequency of 622.08MHz, the actual input reference clock frequencies can be: 622.08, 155.52, 77.76, and 19.44MHz. (See Table 3 on pg. 3.)



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The PLL

The PLL uses a phase detector and configurable dividers to synchronize the output of the VCSO with selected reference clock.

The "Mfin Divider" and "Mfec Divider" divide the VCSO frequency, feeding the result into the phase detector.

The selected input reference clock is divided by the "Rfec Divider". The result is fed into the other input of the phase detector.

The phase detector compares its two inputs. It then outputs pulses to the loop filter as needed to increase or decrease the VCSO frequency and thereby match and lock the divider output's frequency and phase to those of the input reference clock.

Due to the narrow tuning range of the VCSO $(\pm 200 \text{ppm})$, appropriate selection of all of the following are required for the PLL be able to lock: VCSO center frequency, input frequency, and divider selections.

See also "Maintaining PLL Lock:" on pg. 4.

Relationship Among Frequencies and Dividers

The VCSO center frequency must be specified at time of order. The relationship between the VCSO (Fvcso) frequency, the Mfin divider, the Mfec divider, the Rfec divider, and the input reference frequency (Fin) is:

$$Fvcso = Fin \times Mfin \times \frac{Mfec}{Rfec}$$

As an example, for the M2006-12-622.0800, the first five PLL ratios in Table 4 enable use with these corresponding input reference frequencies:

M2006-12-622.0800 VCSO Clock Frequency (MHz) ÷	FEC	R	atio	M2006-12-622.0800 Base Input Ref. = Frequency (MHz) ¹
	1	/	1	622.0800
-	239	/	255	663.7255
622.08	238	/	255	666.5143
-	237	/	255	669.3266
	236	/	255	672.1627

 Table 6: Example FEC PLL Rations and Input Reference Frequencies

 Note 1: Input reference clock ("Fin") can be the base frequency shown divided by "Mfin" (as shown in Table 3 on pg. 3).

Maintaining PLL Lock:

The narrow tuning range of the VCSO requires that the input reference frequency must remain suitable for the current look-up table selection. For example, when switching between "Inverse FEC ratio" and "Non-FEC ratio" look-up table selections (see Table 4 on pg. 3), the input reference frequency must change accordingly in order for the PLL to lock.

An out-of-lock condition due to an inappropriate configuration will typically result in the VCSO operating at its lower or upper frequency rail, which is approximately 200ppm above or below the nominal VCSO center frequency.

See also *"Automatic Protection Switch (APS)"* (next) for an additional issue with regard to phase locking.

Automatic Protection Switch (APS)

The M2006-12 includes a proprietary automatic protection switch (APS) circuit that prevents excessive phase transients of the output clocks upon input reference rearrangement. Upon the occurance of an input reference phase change, or phase transient, PLL bandwidth is lowered by the APS circuit. This limits the rate of phase change in the output clocks. With proper configuration of the external loop filter, the output clocks will comply with MTIE (maximum time interval error) specifications for GR-253 (SONET) and ITU G.813 (SDH) during input reference clock changes.

The APS circuit uses a phase error detector at the phase detector to detect a clock phase change. During normal operation with a stable reference clock, the PLL will be frequency locked and phase locked, resulting in very little error at the phase detector (<1 ns). Upon the selection of a new input reference clock at a different clock phase, a phase error will occur at the phase detector. The APS circuit is triggered with a phase error greater than 4 ns, upon which a narrow PLL bandwidth is applied. When the PLL locks to within 2 ns error at the phase detector, wide bandwidth (normal) operation is resumed.

The APS circuit is not suitable for situations in which an unstable reference is used. Under normal conditions the reference clock jitter should not induce phase jitter at the phase detector beyond 2 ns. (This includes when subjecting the system to jitter tolerance compliance testing.) Because of this, the M2006-12 is not recommended for use with some Stratum DPLL clock sources, or with unstable recovered network clocks intended for loop timing configuration. It is also not recommended for complex FEC ratios where the phase detector is operated at less 1 MHz. For these applications the M2006-02 is suggested. The M2006-02 is identical to the M2006-12 except that it does not include the APS function or the APC function discussed in the following section.

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Automatic Phase Compensation (APC) Pin

The M2006-12 also includes an automatic phase compensation (APC) circuit that can be selectively enabled by asserting the APC input (pin 25) to logic 1. The APC circuit works in conjunction with the APS circuit. When asserted, the APC circuit enables the PLL to absorb most of the phase change of the input clock which reduces re-lock time and the generation of wander. (Wander is created in this case by the generation of extra output clock cycles.)

When asserted, the APC circuit is triggered by same >4 ns phase transient (at the phase detector) that triggers the APS circuit. Once triggered, a new VCSO clock edge is selected for the phase comparator feedback input. (The clock edge selected is the one closest in phase to the new input clock phase.) The residual phase detector phase error following reselection is approximately 3-to-4 ns. The narrow bandwidth selected by the APS circuit minimizes VCSO drifting and switch transients during the process.

It is recommended that APC remain disabled (APC pin low) when the phase detector frequency is less than 4 MHz. Otherwise, the M2006-12 may have difficulty locking to reference upon power-up.

Outputs

The M2006-12 provides a total of two differential LVPECL output pairs: FOUT1 and FOUT0. Because each output pair has its own P divider, the FOUT1 pair and the FOUT_0 can output the two different frequencies at the same time. For example, FOUT1 can output 155.52MHz while FOUT0 outputs 622.08MHz.

External Loop Filter

To provide stable PLL operation, and thereby a low jitter output clock, the M2006-12 requires the use of an external loop filter. This is provided via the provided filter pins (see Figure 4).

Due to the differential signal path design, the implementation requires two identical complementary RC filters as shown here.



Figure 4: External Loop Filter

PLL bandwidth is affected by the "Mfec" value and the "Mfin" value, as well as the VCSO frequency.

The various "Non-FEC ratio" settings can be used to actively change PLL loop bandwidth in a given application. See "FEC PLL Ratio Dividers Look-up Table (LUT)" on pg. 3.

Consult factory for external loop filter component values.



ABSOLUTE MAXIMUM RATINGS¹

Symbol	Parameter	Rating	Unit
V	Inputs	-0.5 to V _{CC} +0.5	V
Vo	Outputs	-0.5 to V _{CC} +0.5	
V _{cc}	Power Supply Voltage	4.6	
T _s	Storage Temperature	-45 to +100	Oo
		Table 7 Absorbute Mass	Dette

Table 7: Absolute Maximum Ratings

Note 1:Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings and stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in Recommended Conditions of Operation, DC Characteristics, or AC Characteristics is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

RECOMMENDED CONDITIONS OF OPERATION

Symbol	Parameter	Min	Тур	Max	Unit
V _{cc}	Positive Supply Voltage	3.135	3.3	3.465	V
T _A	Ambient Operating Temperature	0		+70	°C

Table 8: Recommended Conditions of Operation



ELECTRICAL SPECIFICATIONS

DC Characteristics

Unless stated	otherwise,	$V_{cc} = 3.3 \text{ Volts } \pm 5\%, T_{A}$	= 0 °C to 70 °C, VCSO Fi	requency =	622-6751	MHz, Outputs	terminat	ed with 50 Ω to V _{cc} - 2V
5	Symbol	Parameter		Min	Тур	Max	Unit	Test Conditions
Power Supply	V _{CC}	Positive Supply		3.135	3.3	3.465	V	
	I _{cc}	Power Supply Current			162		mA	
Differential	I _{IH}	Input High Current	nDIF_REF0, nDIF_REF1			5	μΑ	
Inputs			DIF_REF0,nDIF_REF0			150	μΑ	
	I	Input Low Current	nDIF_REF0, nDIF_REF1	-150			μΑ	
			DIF_REF0,nDIF_REF0	-5			μΑ	
	V _{P-P}	Peak to Peak Input	DIF_REF0, nDIF_REF0,	0.15			V	
	V _{CMR}	Common Mode Input	DIF_REF1, nDIF_REF1	0.5		V _{cc} 85	V	
LVCMOS /	V _{IH}	Input High Voltage	REF_SEL,	2		V _{cc} + 0.3	V	
LVTTL	V _{IL}	Input Low Voltage	FIN_SEL1, FIN_SEL0, FEC_SEL0	-0.3		0.8	V	
inputs	C _{in}	Input Capacitance	FEC_SEL2, FEC_SEL3			4	рF	
Pull-down	R _{pulldown}	Internal Pull-down Resistor	(All Inputs		51		kΩ	
	I _{IH}	Input High Current	except FEC_SEL3:0)			150	μΑ	
	I	Input Low Current		-5			μΑ	
Pull-up	R _{pullup}	Internal Pull-down Resistor	FEC_SEL0, FEC_SEL1,		51		kΩ	
	I _{IH}	Input High Current	FEC_SEL2, FEC_SEL3			5	μΑ	
	I	Input Low Current		-150			μΑ	
Differential	V _{OH}	Output High Voltage		V _{cc} - 1.4		V _{cc} - 1.0	V	
Outputs	V _{OL}	Output Low Voltage	FOUT 1, nFOUT 1	V _{cc} - 2.0		V _{cc} - 1.7	V	
	V _{P-P}	Peak to Peak Output	,	0.6		0.85	V	
							Table	9: DC Characteristics

AC Characteristics Unless stated otherwise, $V_{cc} = 3.3$ Volts $\pm 5\%$, $T_A = 0$ °C to 70 °C, VCSO Frequency = 622-675MHz, Outputs terminated with 50 Ω to $V_{cc} - 2V$

	Symbol	Parameter		Min	Тур	Max	Unit	Test Conditions
Input Frequency Range	F _{IN}	Input Frequency	DIF_REF0, nDIF_REF0, DIF_REF1, nDIF_REF1	10		700	MHz	
Output Frequency	F _{FOUT}	Output Frequency Range	FOUT_0, nFOUT_0, FOUT_1, nFOUT_1	100		700	MHz	
	APR	VCSO Pull-Range		<u>+</u> 125	<u>+</u> 200		ppm	
	Φn	Single Side Band	1kHz Offset		-72		dBc/Hz	
		Phase Noise	10kHz Offset		-94		dBc/Hz	Mfin=32, Mfec=1, Rfec=1
		@622.08MHz	100kHz Offset		-123		dBc/Hz	
	J(t)	Jitter (rms) @622.08M	Hz 12kHz to 20MHz		0.5		ps	
	t _{PW}	Output Duty Cycle 1		40	50	60	%	P0, P1 = 1 or 4
	t _R	Output Rise Time ¹		325	450	500	ps	20% to 80%
	t _F	Output Fall Time ¹		325	450	500	ps	20% to 80%
Note 1: Se	Note 1: See Parameter Measurement Information on pg. 8. Table 10: AC Characteristics							

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PARAMETER MEASUREMENT INFORMATION



Duty Cycle



Figure 5: Output Rise and Fall Time

Figure 6: Duty Cycle

DEVICE PACKAGE - 9 x 9mm CERAMIC LEADLESS CHIP CARRIER

Mechanical Dimensions:



Figure 7: Device Package - 9 x 9mm Ceramic Leadless Chip Carrier

ORDERING INFORMATION

For VCSO Frequency (MHz)	Order Part Number
622.08	M2006-12-622.0800
625.00	M2006-12-625.0000
669.3266	M2006-12-669.3266
669.6429	M2006-12-669.6429
	Table 11: Ordering Information

Consult ICS for the availability of other VCSO frequencies.

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